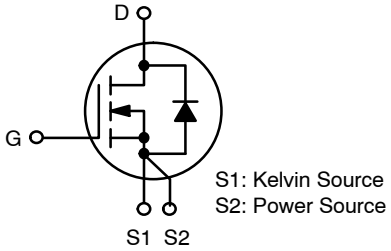
MOSFET - SiC Power, Single N-Channel, TO247-4L

650 V, 19 mΩ, 99 A

NVH4L025N065SC1

$V_{(BR)DSS}$	$R_{DS(ON)}$ MAX	I_D MAX
650 V	28.5 mΩ @ 18 V	99 A



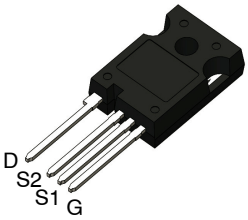
N−CHANNEL MOSFET

Features

- Typ. $R_{DS(on)}$ = 19 mΩ @ V_{GS} = 18 V
  Typ. $R_{DS(on)}$ = 25 mΩ @ V_{GS} = 15 V
- Ultra Low Gate Charge ($Q_{G(tot)}$ = 164 nC)
- Low Capacitance (C_{oss} = 278 pF)
- 100% Avalanche Tested
- AEC−Q101 Qualified and PPAP Capable
- This Device is Pb−Free and is RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV



TO247−4L
CASE 340CJ

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain−to−Source Voltage			V_{DSS}	650	V
Gate−to−Source Voltage			V_{GS}	−8/+22	V
Recommended Operation Values of Gate−to−Source Voltage		T_C < 175°C	V_{GSop}	−5/+18	V
Continuous Drain Current (Note 1)	Steady State	T_C = 25°C	I_D	99	A
Power Dissipation (Note 1)	Steady State	T_C = 25°C	P_D	348	W
Continuous Drain Current (Note 1)	Steady State	T_C = 100°C	I_D	70	A
Power Dissipation (Note 1)	Steady State	T_C = 100°C	P_D	174	W
Pulsed Drain Current (Note 2)	T_C = 25°C		I_{DM}	323	A
Operating Junction and Storage Temperature Range			T_J, T_{stg}	−55 to +175	°C
Source Current (Body Diode)			I_S	75	A
Single Pulse Drain−to−Source Avalanche Energy ($I_{L(pk)}$ = 11.2 A, L = 1 mH) (Note 3)			E_{AS}	62	mJ
Maximum Lead Temperature for Soldering (1/8″ from case for 5 s)			T_L	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. Repetitive rating, limited by max junction temperature.
3. EAS of 62 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 11.2 A, V_{DD} = 50 V, V_{GS} = 18 V.

MARKING DIAGRAM



H4L025065SC1 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NVH4L025N065SC1	TO247−4L	30 Units / Tube

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THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction−to−Case − Steady State (Note 1)	$R_{\theta JC}$	0.43	°C/W
Junction−to−Ambient − Steady State (Note 1)	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
OFF CHARACTERISTICS							
Drain−to−Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 1 mA		650	–	–	V
Drain−to−Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	I_D = 20 mA, referenced to 25°C		–	0.15	–	V/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 650 V	T_J = 25°C	–	–	10	μA
			T_J = 175°C	–	–	1	mA
Gate−to−Source Leakage Current	I_{GSS}	V_{GS} = +18/−5 V, V_{DS} = 0 V		–	–	250	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} = V_{DS}, I_D = 15.5 mA		1.8	2.8	4.3	V
Recommended Gate Voltage	V_{GOP}			−5	–	+18	V
Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 15 V, I_D = 45 A, T_J = 25°C		–	25	–	mΩ
		V_{GS} = 18 V, I_D = 45 A, T_J = 25°C		–	19	28.5	
		V_{GS} = 18 V, I_D = 45 A, T_J = 175°C		–	24	–	
Forward Transconductance	g_{FS}	V_{DS} = 10 V, I_D = 45 A		–	27	–	S
CHARGES, CAPACITANCES & GATE RESISTANCE							
Input Capacitance	C_{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 325 V		–	3480	–	pF
Output Capacitance	C_{OSS}			–	278	–	
Reverse Transfer Capacitance	C_{RSS}			–	25	–	
Total Gate Charge	$Q_{G(TOT)}$	V_{GS} = −5/18 V, V_{DS} = 520 V, I_D = 45 A		–	164	–	nC
Gate−to−Source Charge	Q_{GS}			–	48	–	
Gate−to−Drain Charge	Q_{GD}			–	48	–	
Gate−Resistance	R_G	f = 1 MHz		–	1.5	–	Ω
SWITCHING CHARACTERISTICS							
Turn−On Delay Time	$t_{d(ON)}$	V_{GS} = −5/18 V, V_{DS} = 400 V, I_D = 45 A, R_G = 2.2 Ω inductive load		–	17	–	ns
Rise Time	t_r			–	19	–	
Turn−Off Delay Time	$t_{d(OFF)}$			–	32	–	
Fall Time	t_f			–	8	–	
Turn−On Switching Loss	E_{ON}			–	93	–	μJ
Turn−Off Switching Loss	E_{OFF}			–	84	–	
Total Switching Loss	E_{tot}			–	177	–	
DRAIN−SOURCE DIODE CHARACTERISTICS							
Continuous Drain−Source Diode Forward Current	I_{SD}	V_{GS} = −5 V, T_J = 25°C		–	–	75	A
Pulsed Drain−Source Diode Forward Current (Note 2)	I_{SDM}			–	–	323	
Forward Diode Voltage	V_{SD}	V_{GS} = −5 V, I_{SD} = 45 A, T_J = 25°C		–	4.7	–	V

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
DRAIN−SOURCE DIODE CHARACTERISTICS						
Reverse Recovery Time	t_{RR}	V_{GS} = −5/18 V, I_{SD} = 45 A, dI_S/dt = 1000 A/μs	–	25	–	ns
Reverse Recovery Charge	Q_{RR}		–	171	–	nC
Reverse Recovery Energy	E_{REC}		–	15.8	–	μJ
Peak Reverse Recovery Current	I_{RRM}		–	13.7	–	A
Charge time	Ta		–	14.9	–	ns
Discharge time	Tb		–	10.6	–	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

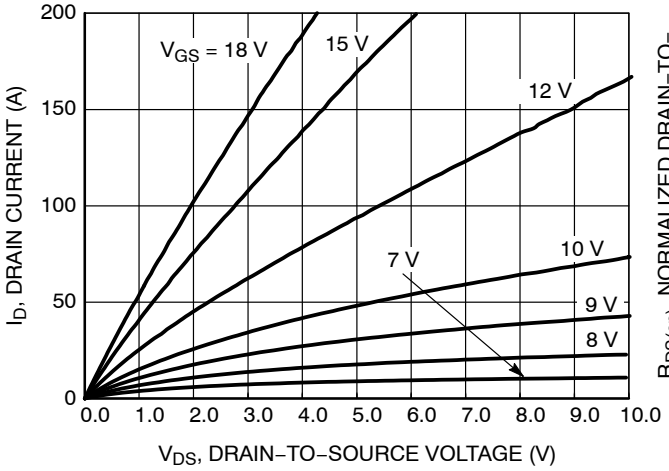


Figure 1. On−Region Characteristics

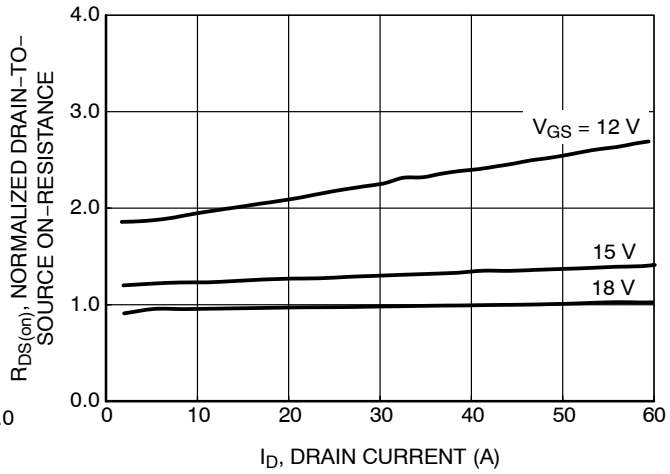


Figure 2. Normalized On−Resistance vs. Drain Current and Gate Voltage

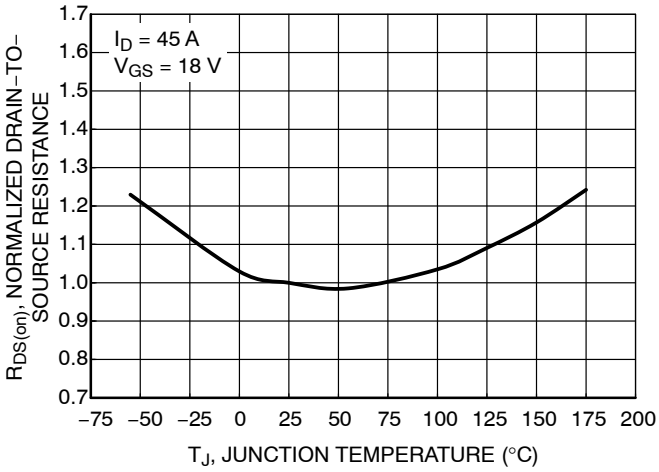


Figure 3. On−Resistance Variation with Temperature

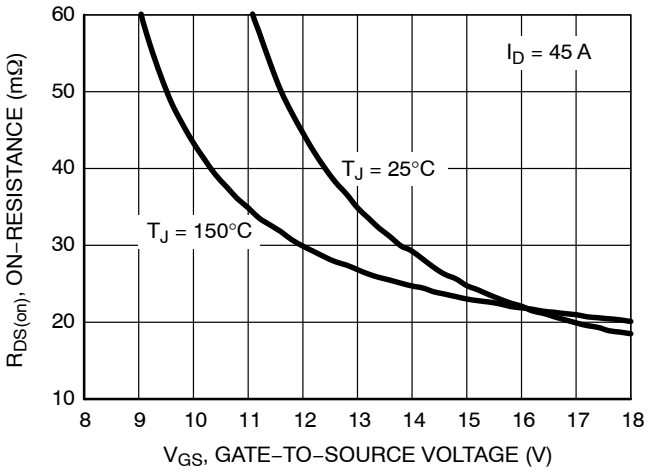


Figure 4. On−Resistance vs. Gate−to−Source Voltage

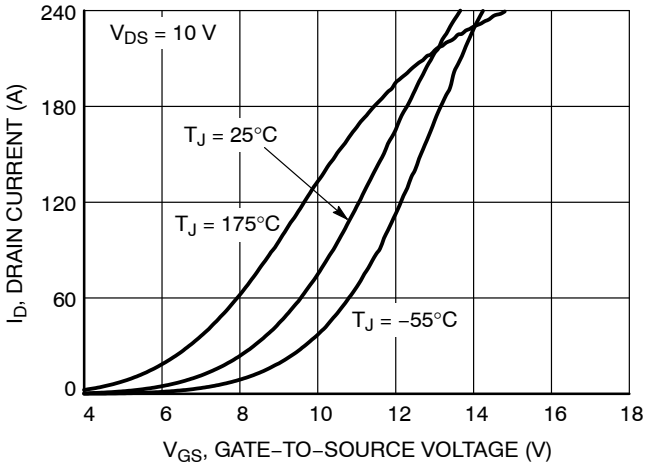


Figure 5. Transfer Characteristics

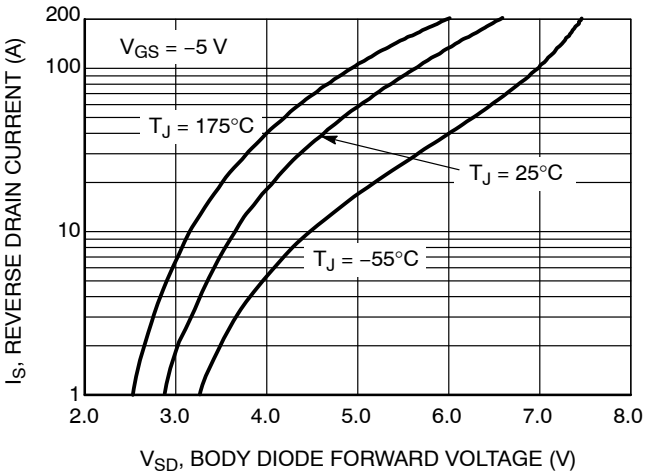


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS

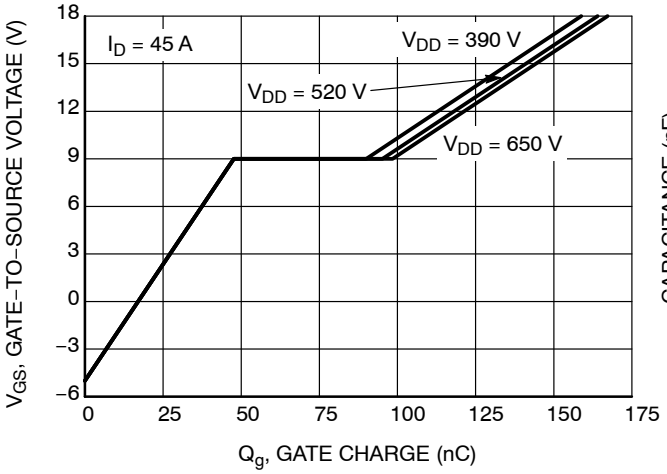


Figure 7. Gate−to−Source Voltage vs. Total Charge

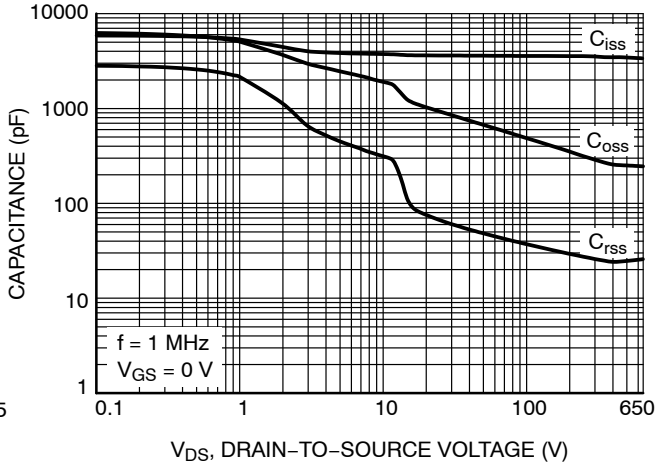


Figure 8. Capacitance vs. Drain−to−Source Voltage

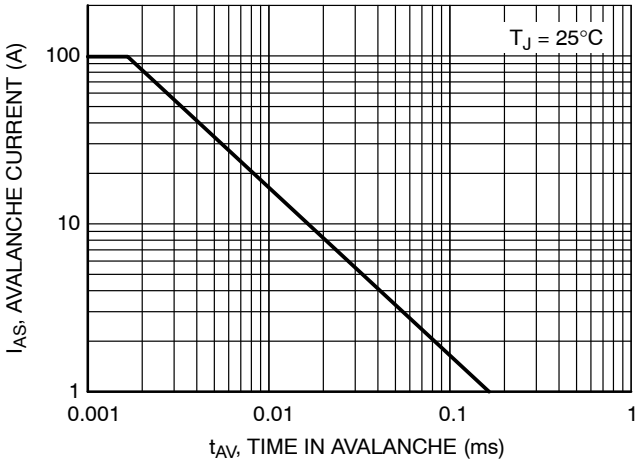


Figure 9. Unclamped Inductive Switching Capability

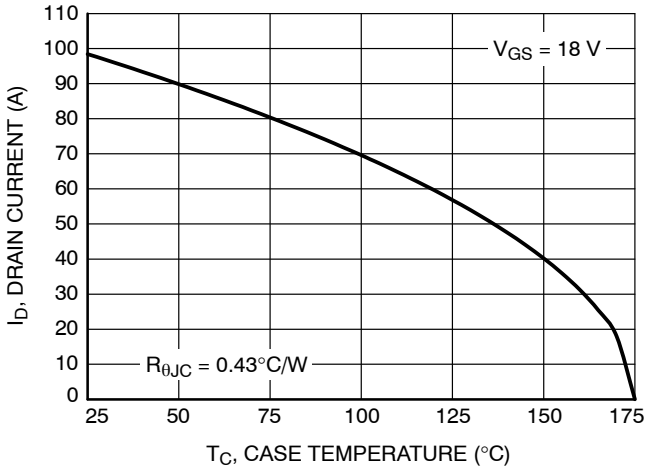


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

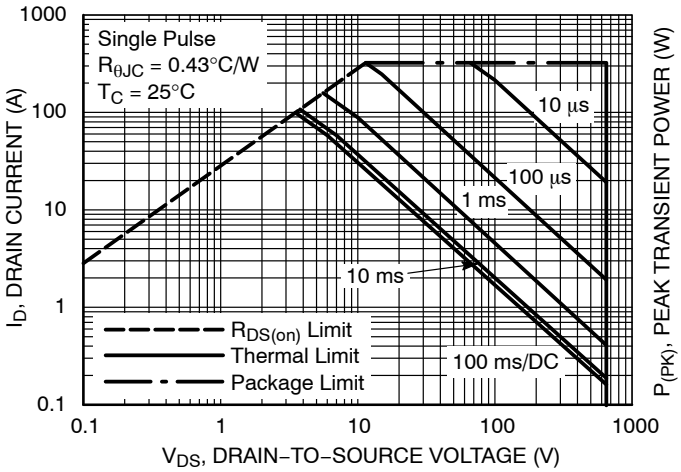


Figure 11. Safe Operating Area

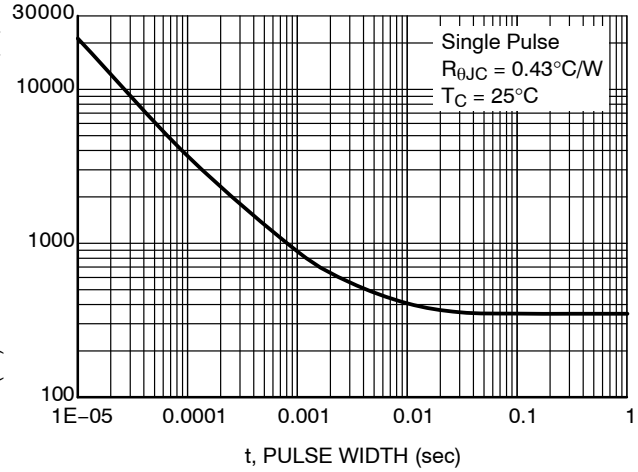


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS

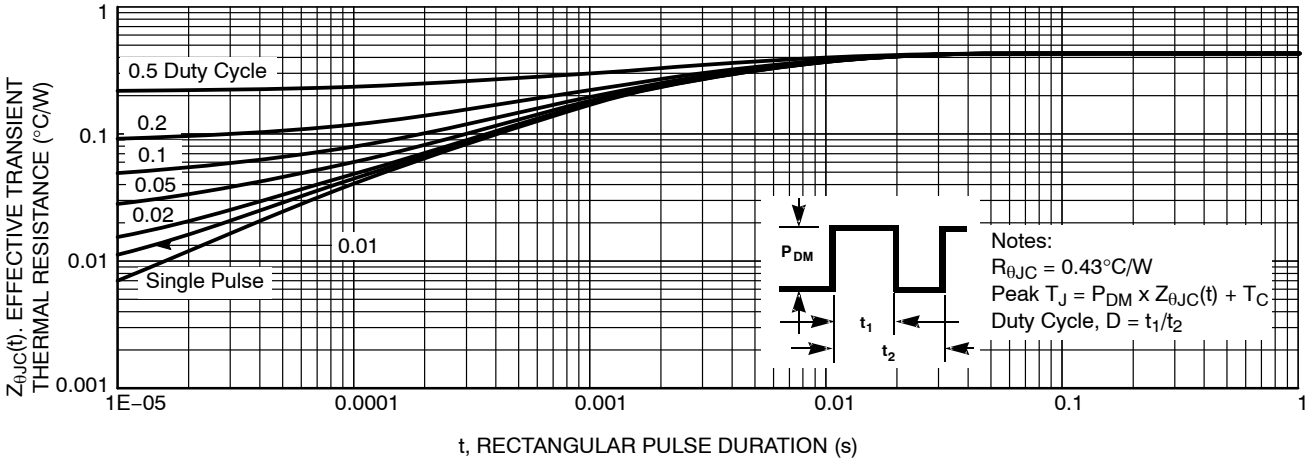
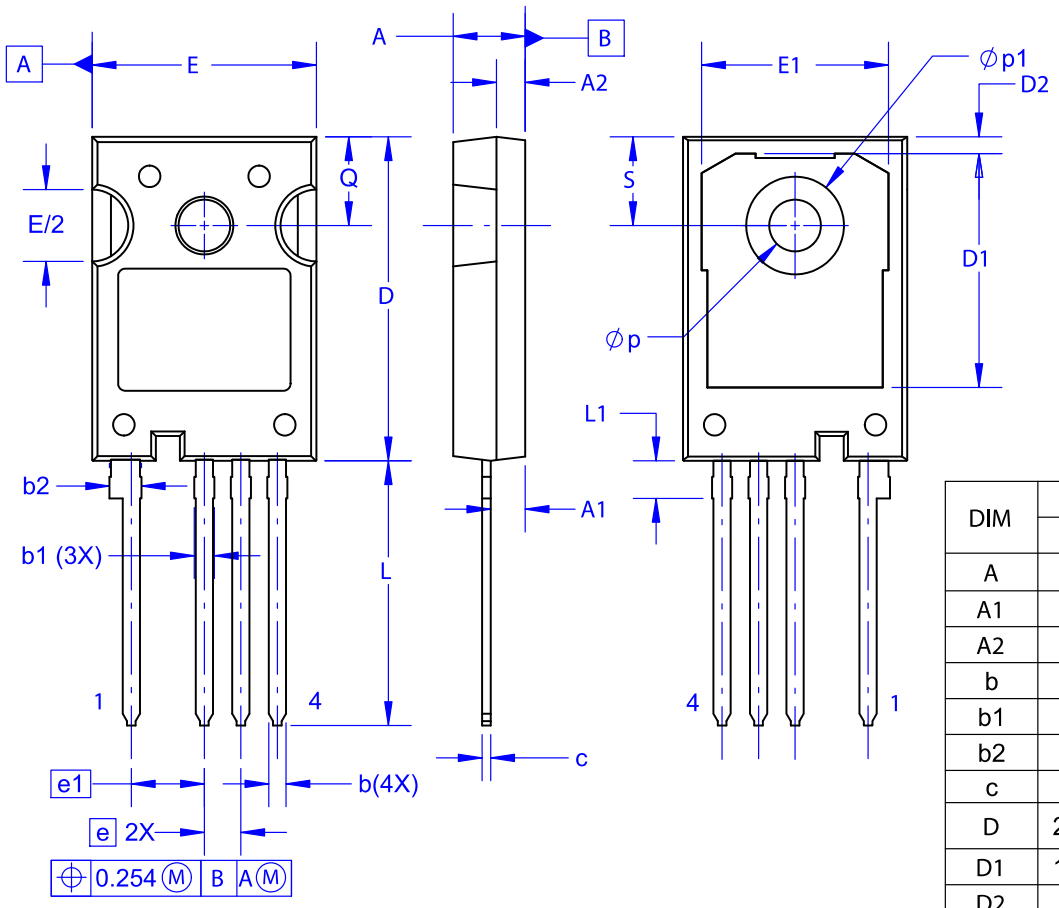


Figure 13. Junction−to−Case Thermal Response

TO−247−4LD
CASE 340CJ
ISSUE A

DATE 16 SEP 2019



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C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
e	2.54 BSC		
e1	5.08 BSC		
E	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
p	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

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